Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
Ŭ.	4526	damascene near1 (pattern structure)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 08:48
L2	11190	damascene and semiconductor and substrate	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 08:50
L3	992	2 and mask and ((light adj source) uv duv)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 08:51
L4	2163	2 and mask and ((light adj source) uv duv lithography)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:50
L5	58	4 and ((anti near reflective near coating) arc barc) and ((photo near active near dielectric) pad)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 08:56
L6	431	4 and ((anti near reflective near coating) arc barc sion) and ((photo near active near dielectric) polymer polymeric polyimide polysilsequioxane)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:51
L7	1	4 and ((anti near reflective near coating) arc barc) and (photo near active near dielectric)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 08:58
L8	1	4 and ((anti near reflective near coating) sion arc barc) and (photo near active near dielectric)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 09:01

L9	144	6 and photolithographic	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:34
L10	144	9 and (method process)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 09:03
L11	9	("6242344").URPN.	USPAT	OR	ON	2005/05/27 10:29
L12	11	("5635423"   "5686354"   "5741626"   "5801094"   "5863835"   "5877075"   "5882996"   "5904565"   "5906910"   "5933761"   "5935762");PN.	US-PGPUB; USPAT; USOCR	OR	ON	2005/05/27 10:32

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L13	162	(US-20030068864-\$ or	US-PGPUB;	OR	ON	2005/05/27 10:38
		US-20030077897-\$ or	USPAT;			
		US-20030129827-\$ or	JPO			
		US-20040023453-\$ or				
		US-20040069410-\$ or				
		US-20040156987-\$ or				
		US-20040166240-\$ or				
		US-20050009290-\$ or				
		US-20050020003-\$).did. or				
		(US-4333227-\$ or US-4339767-\$				
		or US-4378630-\$ or US-4381953-\$				
		or US-4582565-\$ or US-4734384-\$		İ		
		or US-4868617-\$ or US-4994406-\$				
		or US-5252848-\$ or US-5504033-\$				
		or US-5510648-\$ or US-5536675-\$				
		or US-5707896-\$ or US-5753548-\$				
		or US-5753967-\$ or US-5793089-\$				
		or US-5808347-\$ or US-5817568-\$				
		or US-5841166-\$ or US-5869875-\$				
		or US-5886382-\$ or US-5895253-\$				
		or US-5900663-\$ or US-5918137-\$				
		or US-5949104-\$ or				
		US-5950093-\$).did. or				
		(US-5989776-\$ or US-6001414-\$				
		or US-6004883-\$ or US-6008114-\$				
		or US-6025264-\$ or US-6034415-\$				
		or US-6037262-\$ or US-6048772-\$				
		or US-6051468-\$ or US-6054355-\$				
		or US-6060380-\$ or US-6071806-\$				
		or US-6074954-\$ or US-6091110-\$				
		or US-6093632-\$ or US-6100163-\$				
		or US-6100184-\$ or US-6137152-\$				
		or US-6140200-\$ or US-6144096-\$				
		or US-6144099-\$ or US-6153528-\$				
		or US-6153905-\$ or US-6180490-\$				
		or US-6180507-\$ or US-6180518-\$				
		or US-6180995-\$).did. or				
		(US-6190978-\$ or US-6204166-\$				,
1		or US-6211063-\$ or US-6211069-\$				
		or US-6211669-\$ or US-6211669-\$				
		or US-6215152-\$ or US-6218287-\$				
		or US-6221727-\$ or US-6222233-\$				
		or US-6251763-\$ or US-6259160-\$				
		or US-6271552-\$ or US-6274923-\$				
		or US-6284657-\$ or US-6287931-\$				
		or US-6291298-\$ or US-6291333-\$				
		or US-6291296-\$ 01 US-6291333-\$				
		or US-6319820-\$ or US-6329280-\$				
		or US-6348407-\$ or US-6348733-\$				,
		or US-6358842-\$ or US-6365952-\$	;			
		or US-6372635-\$).did. or				
		(US-6376366-\$ or US-6380073-\$				
		or US-6383913-\$ or US-6399432-\$				
		or US-6399449-\$ or US-6413827-\$				
		· · ·				
		or US-6429116-\$ or US-6429129-\$				
		or US-6436824-\$ or US-6440819-\$	,			
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	İ	or US-6509267-\$ or US-6514860-\$			·	
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L14	6	"6506979"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:29
L15	13	"5334488"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:29
L16	3	"6521328"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:29
L17	9	"6349456"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:29
L18	26	14 15 16 17	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:30
L19	25	18 not 9	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 12:30
L20	53	9 and (polyimide (fluorinated adj polyimide) polysilsequioxane benzocyclobutene (parlene adj (n f)) (amorphous adj polytetrafluorothylene))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:52
L21	2959	2 and mask and ((light ad) source) uv duv photolithographic lithography)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:50

L22	873	21 and ((anti near reflective near coating) arc barc sion)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:52
L23	236	22 and (polyimide (fluorinated adj polyimide) polysilsequioxane benzocyclobutene (parlene adj (n f)) (amorphous adj polytetrafluorothylene))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:52
L24	118	23 and (substrate with conductive)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:54
L25	174	23 and (substrate with (conductive metal))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/05/27 14:53